



# **N-Channel Power MOSFET**

800V, 5.5A, 1.2Ω

### **FEATURES**

- Super-Junction technology
- High performance due to small figure-of-merit
- High ruggedness performance
- High commutation performance
- Pb-free plating
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

KEY PERFORMANCE PARAMETERS			
PARAMETER	ER VALUE UNIT		
$V_{DS}$	800	V	
R <sub>DS(on)</sub> (max)	1.2	Ω	
$Q_g$	19.4	nC	





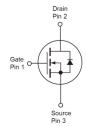


### **APPLICATION**

- Power Supply
- Lighting

TO-251 (IPAK)





Notes: MSL 3 (Moisture Sensitivity Level) for TO-252 (D-PAK) per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V <sub>DS</sub>	800	V
Gate-Source Voltage		V <sub>GS</sub>	±30	V
Continuous Drain Current (Note 1)	$T_C = 25^{\circ}C$		5.5	А
	$T_C = 100$ °C	I <sub>D</sub>	3.4	А
Pulsed Drain Current (Note 2)		I <sub>DM</sub>	16.5	А
Total Power Dissipation @ T <sub>C</sub> = 25°C	;	P <sub>DTOT</sub>	110	W
Single Pulsed Avalanche Energy (Note	9 3)	E <sub>AS</sub>	121	mJ
Single Pulsed Avalanche Current (Not	e 3)	I <sub>AS</sub>	2.2	А
Operating Junction and Storage Tem	perature Range	T <sub>J</sub> , T <sub>STG</sub>	- 55 to +150	°C

Version: B1706





THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction to Case Thermal Resistance	R <sub>eJC</sub>	1.14	°C/W
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	62	°C/W

**Notes:**  $R_{\Theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins.  $R_{\Theta JA}$  is guaranteed by design while  $R_{\Theta CA}$  is determined by the user's board design.  $R_{\Theta JA}$  shown below for single device operation on FR-4 PCB with minimum recommended footprint in still air.

ELECTRICAL SPECIFICA	1					
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static (Note 4)						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	$BV_{DSS}$	800			V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	$V_{GS(TH)}$	2		4	V
Gate Body Leakage	$V_{GS} = \pm 30V, V_{DS} = 0V$	I <sub>GSS</sub>			±100	nA
Zero Gate Voltage Drain Current	$V_{DS} = 800V, V_{GS} = 0V$	I <sub>DSS</sub>			1	μΑ
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 2.75A$	R <sub>DS(on)</sub>		0.9	1.2	Ω
Dynamic (Note 5)						
Total Gate Charge		$Q_g$		19.4		
Gate-Source Charge	$V_{DS} = 380V, I_{D} = 5.5A,$	$Q_{gs}$		3.4		nC
Gate-Drain Charge	$V_{GS} = 10V$	$Q_{gd}$		9.6		
Input Capacitance	$V_{DS} = 100V, V_{GS} = 0V,$	C <sub>iss</sub>		685		_
Output Capacitance	f = 1.0MHz	C <sub>oss</sub>		62		pF
Gate Resistance	F = 1MHz, open drain	$R_g$		3.4		Ω
Switching (Note 6)						
Turn-On Delay Time	$V_{DD} = 380V,$ $R_{GEN} = 25\Omega,$ $I_{D} = 5.5A, V_{GS} = 10V,$	t <sub>d(on)</sub>		22		
Turn-On Rise Time		t <sub>r</sub>		11		
Turn-Off Delay Time		t <sub>d(off)</sub>		55		ns
Turn-Off Fall Time	$\frac{1}{1} = 3.3A,  v_{GS} = 10V,$	t <sub>f</sub>		10		]
Source-Drain Diode (Note 4)						
Forward On Voltage	I <sub>S</sub> = 5.5A, V <sub>GS</sub> = 0V	$V_{SD}$			1.4	٧
Reverse Recovery Time	V <sub>B</sub> = 100V, I <sub>S</sub> = 5.5A	t <sub>rr</sub>		240		ns
Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	Q <sub>rr</sub>		2.5		μC

#### Notes:

- 1. Current limited by package.
- 2. Pulse width limited by the maximum junction temperature.
- 3. L = 50mH,  $I_{AS} = 2.2A$ ,  $V_{DD} = 50V$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^{\circ}C$
- 4. Pulse test: PW  $\leq$  300 $\mu$ s, duty cycle  $\leq$  2%.
- 5. For DESIGN AID ONLY, not subject to production testing.
- 6. Switching time is essentially independent of operating temperature.

Version: B1706





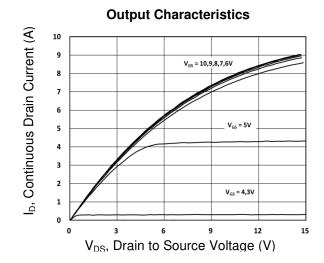
# **ORDERING INFORMATION**

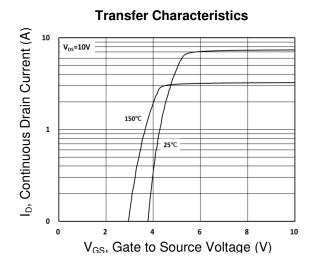
PART NO.	PACKAGE	PACKING
TSM80N1R2CH C5G	TO-251 (IPAK)	75pcs / Tube
TSM80N1R2CP ROG	TO-252 (DPAK)	2,500pcs / 13" Reel

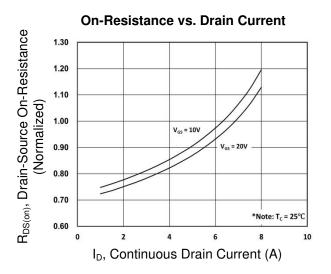


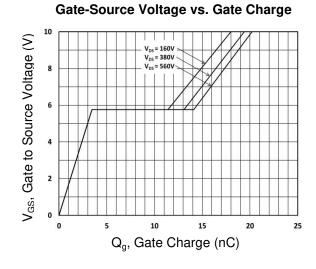
#### **CHARACTERISTICS CURVES**

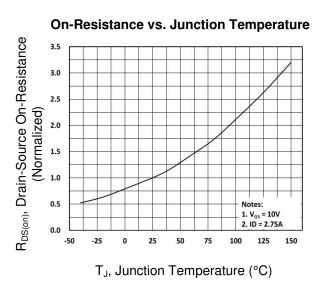
 $(T_C = 25^{\circ}C \text{ unless otherwise noted})$ 

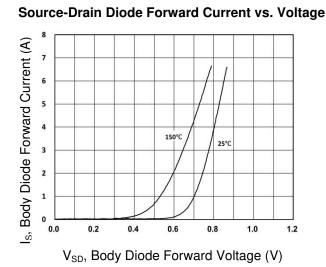










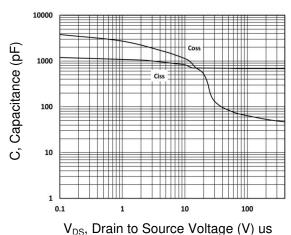




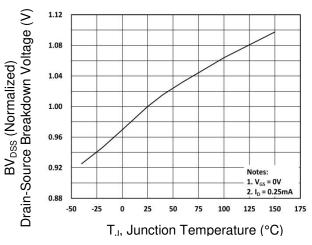
### **CHARACTERISTICS CURVES**

 $(T_C = 25^{\circ}C \text{ unless otherwise noted})$ 

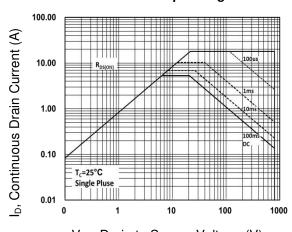
## Capacitance vs. Drain-Source Voltage



### BV<sub>DSS</sub> vs. Junction Temperature

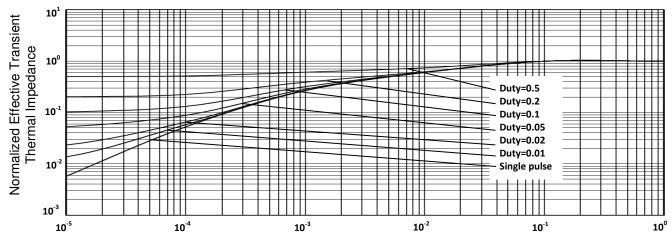


### **Maximum Safe Operating Area**



## $V_{\text{DS}},$ Drain to Source Voltage (V)

### Normalized Thermal Transient Impedance, Junction-to-Case



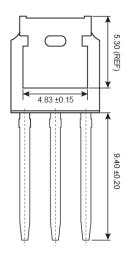
Square Wave Pulse Duration (s)



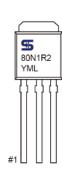


### PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

# **TO-251 (IPAK)** 6.60 ±0.20 5.33 ±0.15 1.02 (REF) 0.53 ±0.05 ->- $6.10\pm0.10$ 1.07 ±0.10 0.82 ±0.05 → 2.28 (BSC) ← 0.78 ±0.10 0.53 (BSC) →

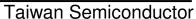


### **MARKING DIAGRAM**



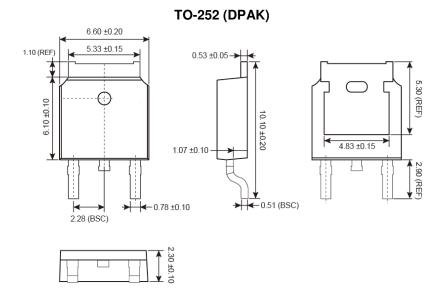
- Y = Year Code
- **M** = Month Code for Halogen Free Product
  - O =Jan
- P =Feb Q =Mar R =Apr

  - **S** =May **T** =Jun
- **U** =Jul **V** =Aug
- **W** =Sep **X** =Oct Y =Nov Z =Dec
- **L** = Lot Code  $(1\sim9, A\sim Z)$

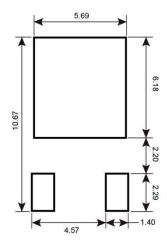




### PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)



### SUGGESTED PAD LAYOUT (Unit: Millimeters)



### **MARKING DIAGRAM**



Y = Year Code

**M** = Month Code for Halogen Free Product

O =Jan P =Feb Q =Mar R =Apr

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**L** = Lot Code  $(1\sim9, A\sim Z)$ 

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